

ENGLISH

Datasheet RS50 Aluminium Housed Resistors



Product details:

Manufactured in line with the requirements of MIL 18546 and IEC 115, designed for direct heatsink mounting with thermal compound to achieve maximum performance

- High Power to volume
- Wound to maximise High Pulse Capability
- Values from R005 to 100K
- Custom designs welcome
- RoHS Compliant

Heat dissipation:

Whilst the use of proprietary heat sinks with lower thermal resistances is acceptable, uprating is not recommended. For maximum heat transfer it is recommended that a heat sink compound be applied between the resistor base and heat sink chassis mounting surface. It is essential that the maximum hot spot temperature of 200°C is not exceeded, therefore, the resistor must be mounted on a heat sink of correct thermal resistance for the power being dissipated.



Power Overload Pulse Energy RS50 250.0 200.0 Multiple of Rated Power Pulse Energy Joules 1000 50.0 0.0 0.100 1.000 1,000 10,000 100,000 Duration of Overload (Secs) Resistance(Ohms) Multiple of Rated Power Derating Curve RS50 Surface Temp Rise RS50 Surface Temp Rise °C %Full Power 80 100 120 140 160 180 200 25 40 Ambient Temperture °C Power Dissipation Watts

Temp. Rise & Power Dissipation



Specifications:

Style MIL-R 18546	RE 75					
Power rating on std. heatsink @25°C	50					
Watts with no heatsink @25°C	14					
Resistance range	R01-86K					
Limiting element voltage	1250					
Voltage proof AC Peak	3500					
Voltage proof AC rms.	2500					
Approx weight gms	32					
Typical surface rise 56 mount	3.0					
Standard heatsink	535cm ²					
	1mm					

RS10-RS300 Standard:





Dimensions (mm):

Size	A Max	B Max	C Max	D Max	E Max	F <u>+</u> 0.3	G <u>+0.3</u>	H Max	J Max	K Max	L <u>+</u> 0.25
5650	28.0	72.5	14.8	14.2	49.1	39.7	21.4	8.4	5.2	2.6	3.2